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# FFPF06UP20S Ultrafast Rectifier

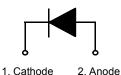
### **Features**

- Ultrafast with soft recovery (@ I<sub>F</sub> = 1A), < 35ns</li>
- Reverse Voltage, 200V
- Forward Voltage (@  $T_C$  = 100°C), < 1.1V
- Enhanced Avalanche Energy

### **Applications**

- · Power switching circuits
- · Output rectifiers
- · Freewheeling diodes
- · Switching mode power supply





## Absolute Maximum Ratings (per diode) T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 100°C	6	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	60	А
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

### Thermal Characteristics T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	4.5	°C/W

## **Electrical Characteristics** (per diode) T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	Maximum Instantaneous Forward Voltage $I_F = 6A$ $I_F = 6A$	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C			1.15 1.10	V
I <sub>RM</sub> *	Maximum Instantaneous Reverse Current @ rated V <sub>R</sub>	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-		100 500	μΑ
t <sub>rr</sub> I <sub>rr</sub> Q <sub>rr</sub>	Reverse Recovery Time Reverse Recovery Current Reverse Recovery Charge (I <sub>F</sub> =6A, di/dt = 200A/µs)		- - -	31 1.6 24.8	- - -	ns A nC
t <sub>rr</sub>	Maximum Reverse Recovery Time (I <sub>F</sub> =1A, di/dt = 100A/μs)		-	-	35	ns
W <sub>AVL</sub>	Avalanche Energy (L=40mH)		5	-	-	mJ

<sup>\*</sup> Pulse Test: Pulse Width=300µs, Duty Cycle=2%

## **Typical Performance Characteristics**

Figure 1. Typical Forward Voltage Drop vs. Forward Current

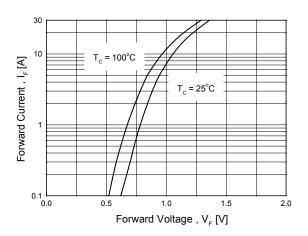


Figure 3. Typical Junction Capacitance

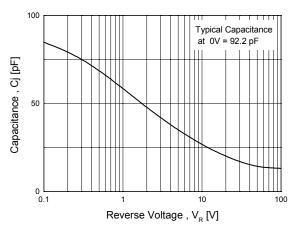


Figure 5. Typical Reverse Recovery Current vs. di/dt

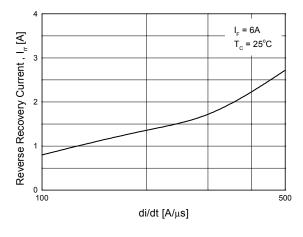


Figure 2. Typical Reverse Current vs. Reverse Voltage

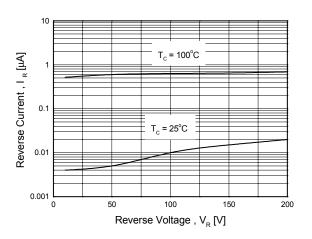


Figure 4. Typical Reverse Recovery Time vs. di/dt

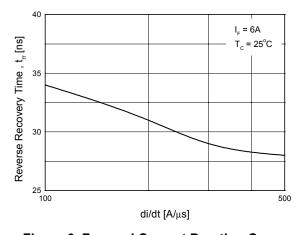
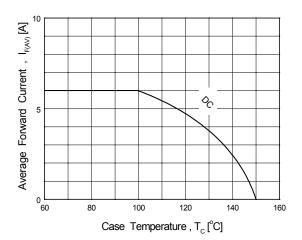
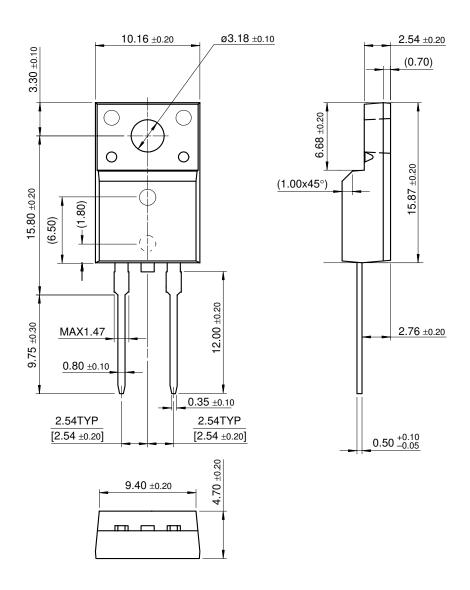


Figure 6. Forward Current Derating Curve



## **Mechanical Dimensions**

# TO-220F-2L



Dimensions in Millimeters

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